

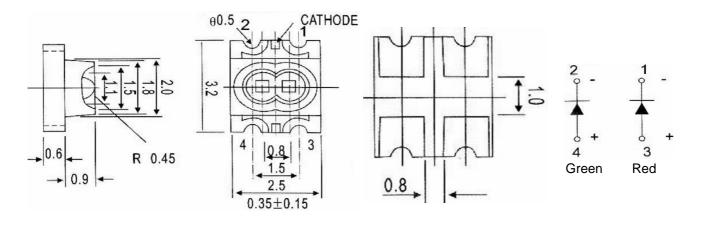


## Applications

Interior automotive lighting

 Optical indicators
 Communication Products
 Backlighting
 Toys

#### **Technical Drawing**



**Recommended Soldering Pattern** 



All dimensions in mm tolerance is

± 0.1mm unless otherwise noted.

			Top View LED				
		Green	ŀ	Red			
		Part No.:	M11G7001				
	(	Customer:					
IΑ	TI·	Chui	DATE	06 12 2009			

DF	RW:	Dong	CHKD	Chang	MATL:	Chui	DATE	06.12.2009
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# Absolute Maximum Ratings

Ta=25°C

Item	Symbol	GaP	AlGalnP	Unit
Power Dissipation	P <sub>D</sub>	72		mW
DC Forward Current	I <sub>F</sub>	30		mA
Plused Forward Current	I <sub>FP</sub> *	100		mA
Reverse Voltage	V <sub>R</sub>	5		V
Operating Temperature	T <sub>OP</sub>	-30 to 80		°C
Storage Temperature	T <sub>ST</sub>	-40 1	to 85	°C

\* 0.1 msec pulse, 10% duty cycle

# Electrcal / Optical Characteristics

I<sub>F</sub>=5mA Ta=25°C

Ermitting Color		Green	Red	
Material		GaP	AlGalnP	
Forward Voltage	typ.	2.1	2.0	V <sub>F</sub>
Forward voltage	max.	2.4	2.4	V <sub>F</sub>
Wavelength	λD	571	639	nm
-	λP			nm
typ.	Δλ			nm
Color Temperature	min.			K
Color remperature	max.			K
Luminous Intensity *	min.	14	28	mcd
Luminous intensity	typ.	21	50	mcd
Reverse Current	max.		μA	
Viewing Angle	2Θ1/2	120		

\* Per NIST standards

CHKD

		SMT Top View LED						
			Red					
			Part No.:	M11G70	01			
		C	Customer:					
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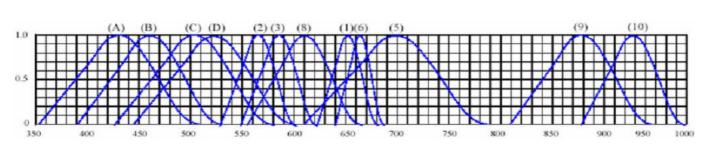
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Curve



Wavelength (nm)

**Relative Intensity vs Wavelength** 

(4)		(0)	
(1)	GaAsP / GaAs	(9)	GaAlAs
	655nm Red		880nm
(2)	GaP	(10)	GaAs & GaAlAs
	568nm Yellow Green		940nm
(3)	GaAsP / GaP	(A)	GaN
	585nm Yellow		430nm Blue
(4)	GaAsP / GaP	(B)	InGaN
	635nm Orange & Red		470nm Blue
(5)	GaP	(C)	InGaN
. ,	700nm Red		502nm Green
(6)	GaAlAs / GaAs	(D)	InGaN
. ,	660nm Red		523nm Green
(8)	GaAsP / GaP		
	610nm Red		

				SMT Top View LED Green Red				
				ŀ		Part No.: <b>M11G7001</b>		001
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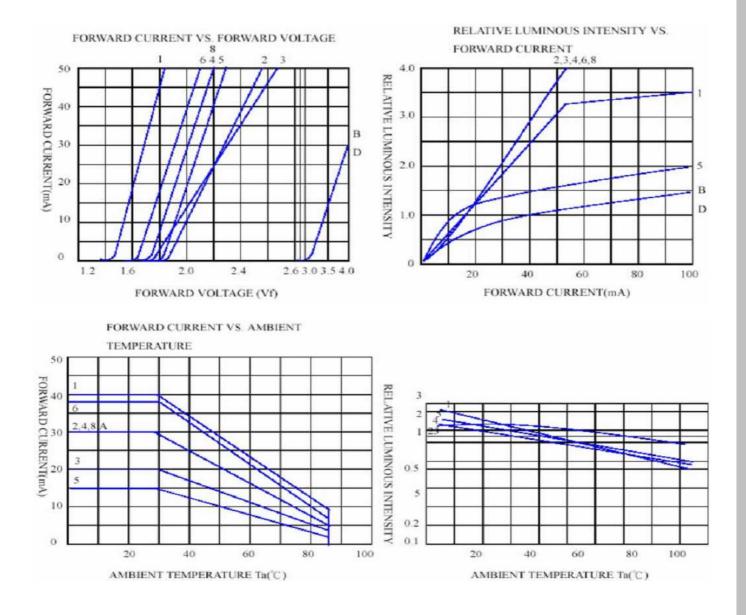
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#### Curve



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						Green	I	Red		
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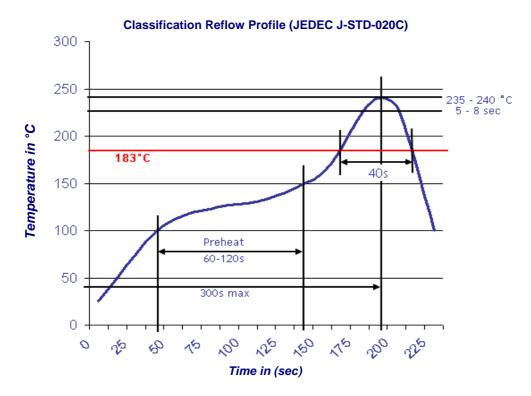
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## **Solder Condition**

## Lead Free Solder

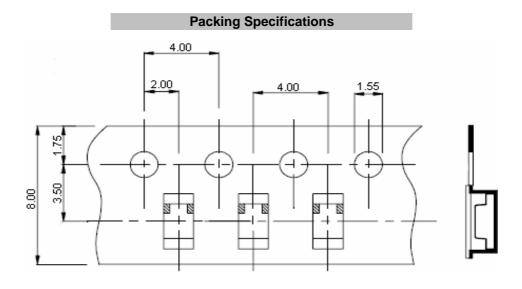


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						Green		Red		
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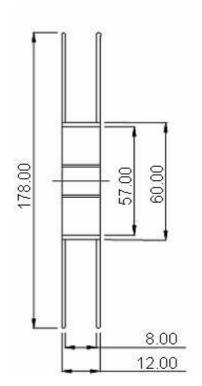
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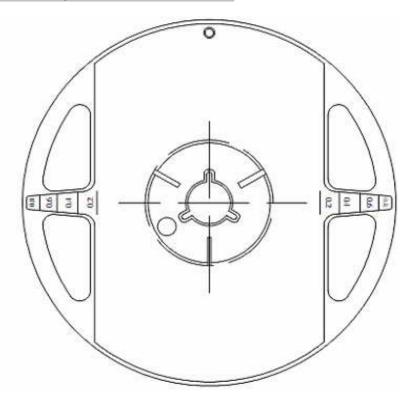






**Reel Specifications** 





						SMT Green	Top View LED	) Red
					Part No.: <b>M11G7001</b>			001
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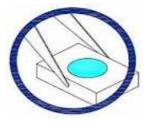




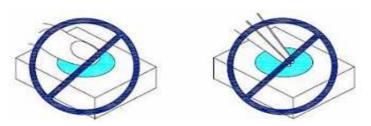
### Handling Precautions

Compare to epoxy encapsulant that is hard and brittle, silicone is softer and flexible. Although ist characteristic significantly reduces thermal stress, it is more susceptible to damage by external mechanical force. As a result, special handling precautions need to be observed during assembly using silicone encapsulated LED products. Failure to comply might leads to damage and premature failure of th LED.

1. Handle the component along the side surfaces by using forceps or appropriate tools



2. Do not directly touch or handle the silicone lens surfance. It may damage the internal circuitry.



3. Do not stack together assembled PCBs containing exposed LEDs. Outside impact may scratch the silicone lens or damage the internal circuitry.



			SMT Top View LED					
				Green	ŀ	Red		
				Part No.:	M11G70	M11G7001		
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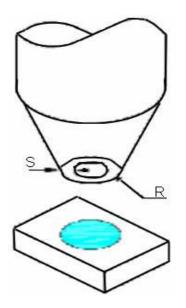
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- 4. The outer diameter of the TOP LED pickup nozzle should not exceed the size of the LED to prevent air leaks. The inner diameter of the nozzle should be as large as possible.
- 5. A pliable material is suggested for the nozzle tip to avoid scratching or damaging the LED surface during pickup.
- 6. The dimensions of the component must be accurately programmed in the pick-and-place machine to insure precise pickup and avoid damage during production.



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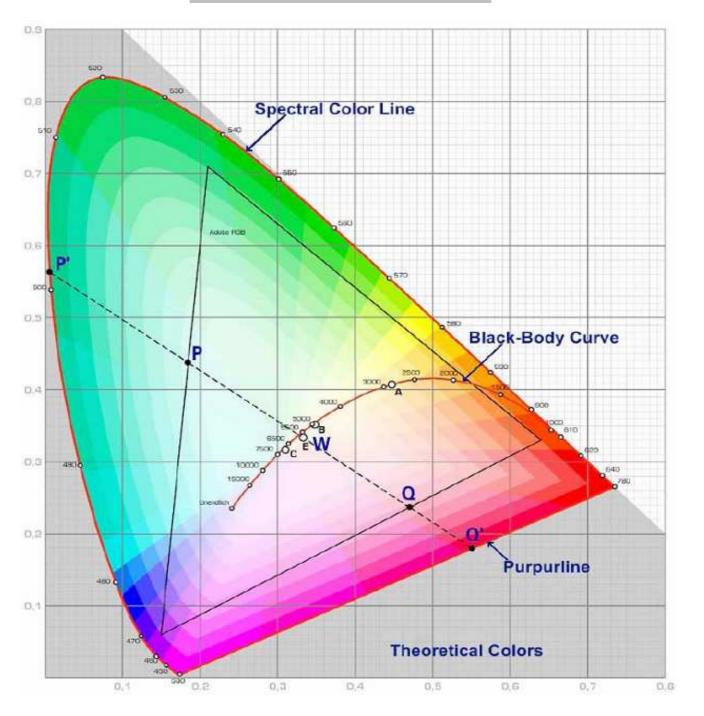
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Color table curve



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					Green Red		Red	
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					Customer:			
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